

Features

- Avalanche rated
- Low V_F
- Good trade off between leakage current and forward voltage drop
- High frequency operation
- Avalanche capability specified

Description

Single Schottky rectifier, suited for high frequency switch mode power supply.

Packaged in TO-220AB, TO-220FPAB, and I²PAK this device is intended to be used in notebook and game station adaptors, providing in these applications a good efficiency at both low and high load.

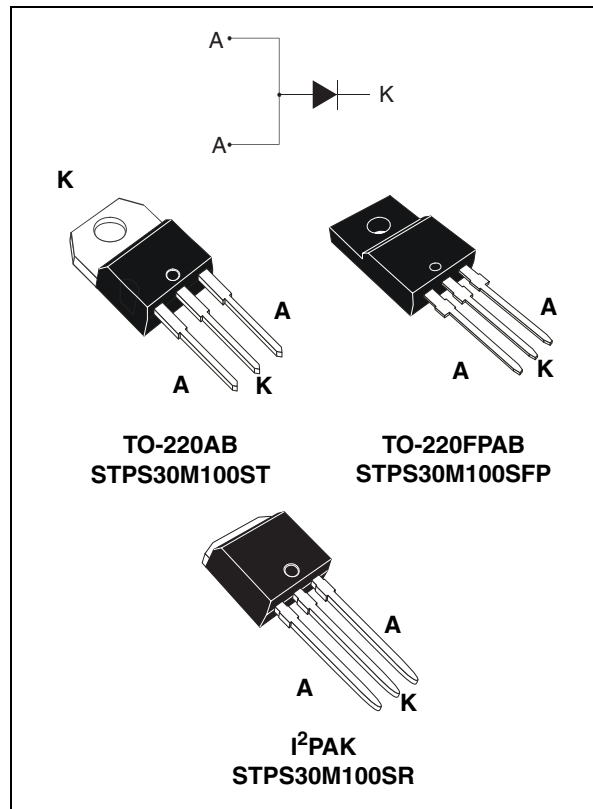


Figure 1. Electrical characteristics (a)

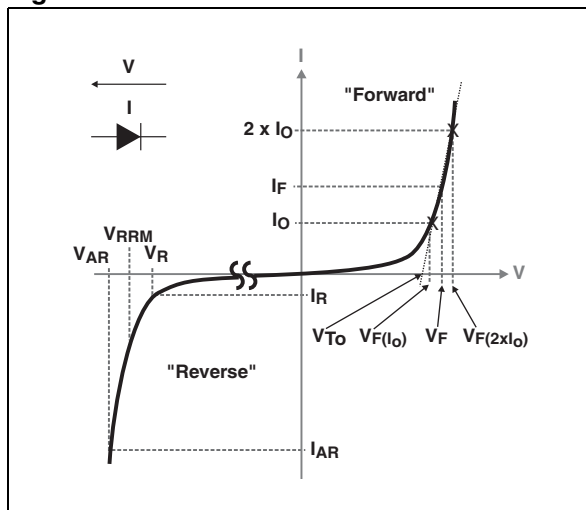


Table 1. Device summary

$I_{F(AV)}$	30 A
V_{RRM}	100 V
T_j (max)	150° C
V_F (typ)	0.385 V

- a. V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in Figure 14. V_{AR} and I_{AR} are pulse measurements ($t_p < 1 \mu s$). V_R , I_R , V_{RRM} and V_F are static characteristics

1 Characteristics

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Table 2. Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		100	V
I _{F(RMS)}	Forward rms current		60	A
I _{F(AV)}	Average forward current $\delta = 0.5$	T _c = 125 °C	30	A
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	300	A
P _{ARM}	Repetitive peak avalanche power		t _p = 1 μ s T _j = 25 °C	W
V _{ARM} ⁽¹⁾	Maximum repetitive peak avalanche voltage	t _p < 1 μ s T _j < 150 °C I _{AR} < 66 A	120	V
V _{ASM} ⁽¹⁾	Maximum single pulse peak avalanche voltage	t _p < 1 μ s T _j < 150 °C I _{AR} < 66 A	120	V
T _{stg}	Storage temperature range		-65 to + 175	°C
T _j	Maximum operating junction temperature ⁽²⁾		150	°C

1. Refer to [Figure 14](#).
2. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	TO-220AB, I ² PAK	1	°C/W
		TO-220FPAB	4	

Table 4. Static electrical characteristics with all leads connected on board

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25° C	V _R = V _{RRM}			175	μ A
		T _j = 125° C		20	50	mA	
		T _j = 25° C	V _R = 70 V			60	μ A
		T _j = 125° C		10	20	mA	
V _F ⁽²⁾	Forward voltage drop	T _j = 25° C	I _F = 5 A		0.475		V
		T _j = 125° C		0.385			
		T _j = 25° C	I _F = 10 A		0.555		
		T _j = 125° C		0.475			
		T _j = 25° C	I _F = 15 A		0.620	0.660	
		T _j = 125° C		0.525	0.565		
		T _j = 25° C	I _F = 30 A		0.740	0.800	
		T _j = 125° C		0.605	0.655		

1. Pulse test: t_p = 5 ms, $\delta < 2\%$
2. Pulse test: t_p = 380 μ s, $\delta < 2\%$

To evaluate the conduction losses use the following equation:
 $P = 0.475 \times I_{F(AV)} + 0.006 \times I_F^2(RMS)$

Figure 2. Conduction losses versus average current

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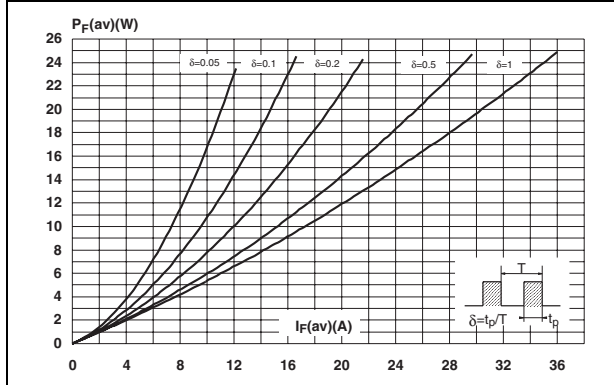


Figure 3. Average forward current versus ambient temperature (delta = 0.5)

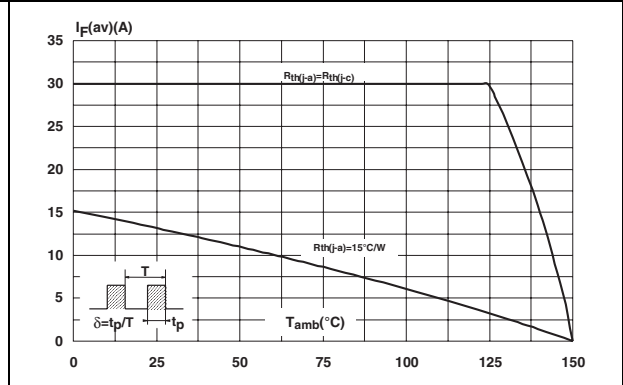


Figure 4. Normalized avalanche power derating versus pulse duration

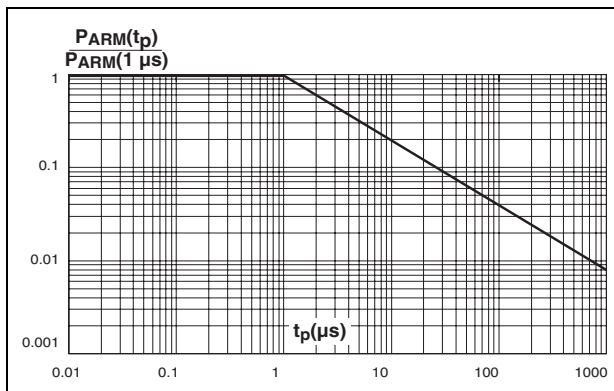


Figure 5. Normalized avalanche power derating versus junction temperature

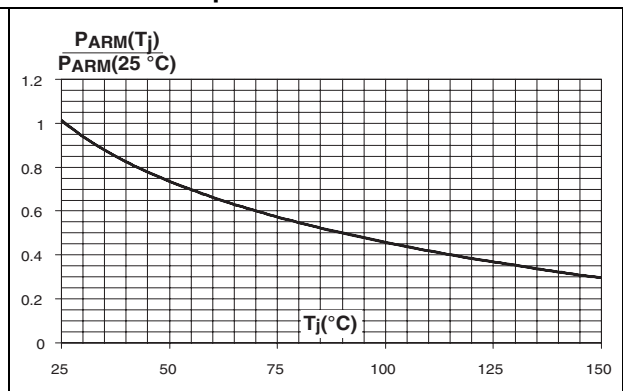


Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values)

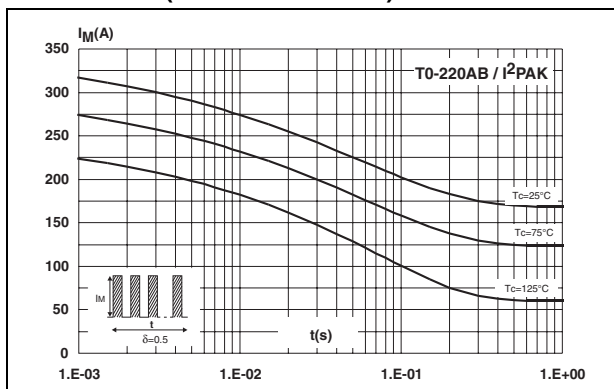


Figure 7. Relative variation of thermal impedance junction to case versus pulse duration

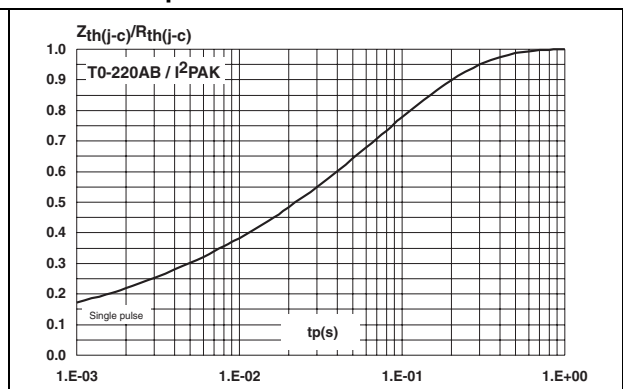


Figure 8. Non repetitive surge peak forward current versus overload duration (maximum values) (TO-220FPAB)

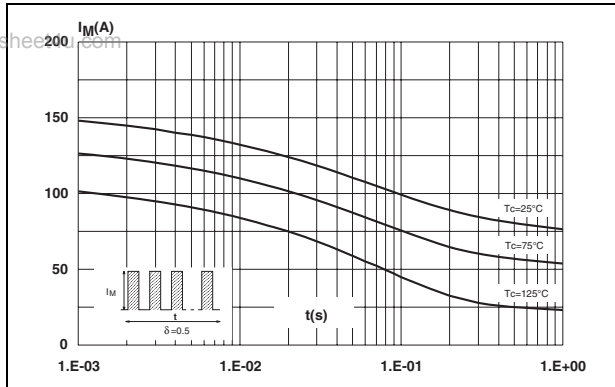


Figure 9. Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAB)

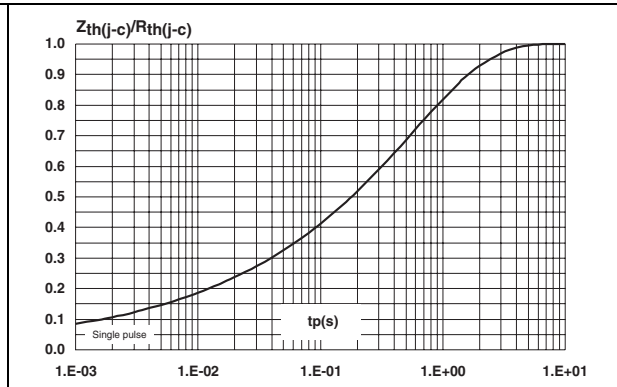


Figure 10. Reverse leakage current versus reverse voltage applied (typical values)

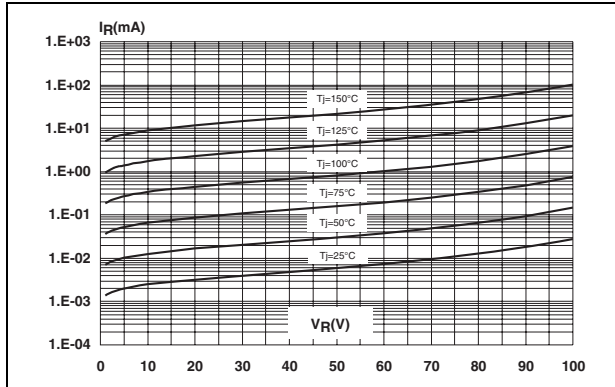


Figure 11. Junction capacitance versus reverse voltage applied (typical values)

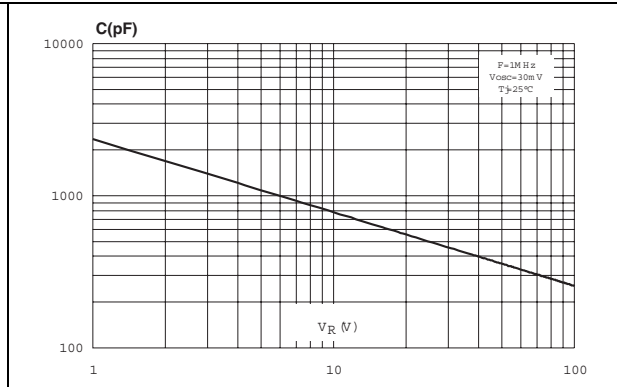


Figure 12. Forward voltage drop versus forward current (high level)

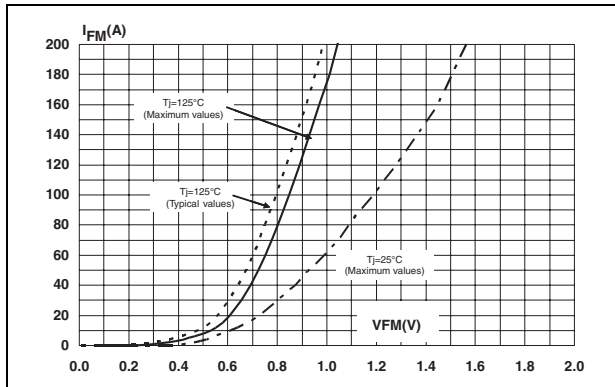


Figure 13. Forward voltage drop versus forward current (low level)

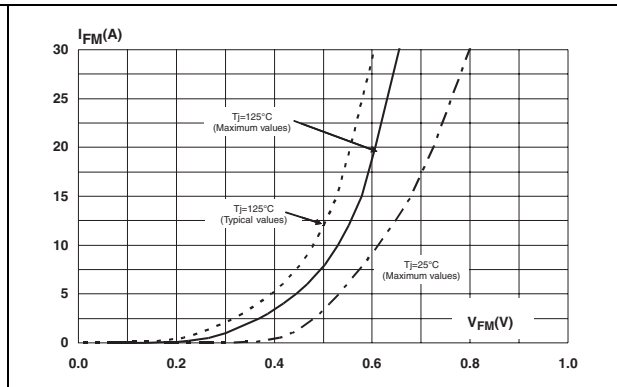
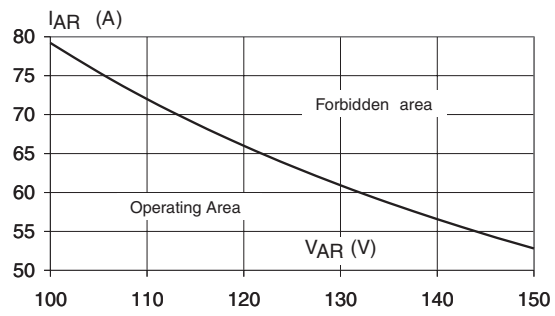


Figure 14. Reverse safe operating area ($t_p < 1 \mu\text{s}$ and $T_j < 150 \text{ }^\circ\text{C}$)

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2 Package Information

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- Epoxy meets UL94,V0
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 5. TO-220AB dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	

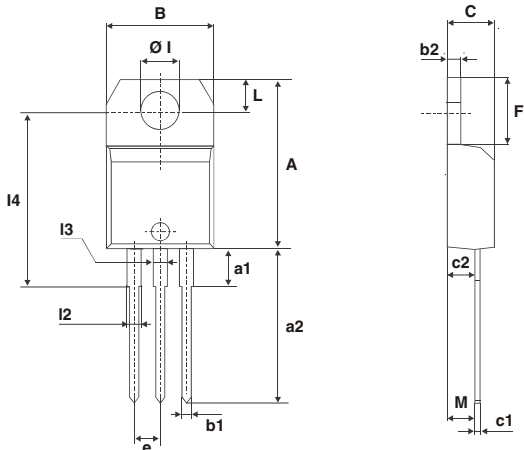


Table 6. TO-220FPAB dimensions

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Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.4	4.6	0.173	0.181
B	2.5	2.7	0.098	0.106
D	2.5	2.75	0.098	0.108
E	0.45	0.70	0.018	0.027
F	0.75	1	0.030	0.039
F1	1.15	1.50	0.045	0.059
F2	1.15	1.50	0.045	0.059
G	4.95	5.20	0.195	0.205
G1	2.4	2.7	0.094	0.106
H	10	10.4	0.393	0.409
L2	16 Typ.		0.63 Typ.	
L3	28.6	30.6	1.126	1.205
L4	9.8	10.6	0.386	0.417
L5	2.9	3.6	0.114	0.142
L6	15.9	16.4	0.626	0.646
L7	9.00	9.30	0.354	0.366
Dia.	3.00	3.20	0.118	0.126

Table 7. I²PAK dimensions

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Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
b	0.70		0.93	0.028		0.037
b1	1.20		1.38	0.047		0.054
b2	1.25	1.40		0.049	0.055	
c	0.45		0.60	0.018		0.024
c2	1.21		1.36	0.048		0.054
D	8.95		9.35	0.352		0.368
e	2.44		2.64	0.096		0.104
E	10.00		10.28	0.394		0.405
L	13.10		13.60	0.516		0.535
L1		3.75			0.148	
L2	1.27		1.40	0.050		0.055
V		5°			5°	
V4		45°			45°	

3 Ordering information

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Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30M100ST	STPS30M100ST	TO-220AB	2.3 g	50	Tube
STPS30M100SFP	STPS30M100SFP	TO-220FPAB	2.0 g	50	Tube
STPS30M100SR	STPS30M100SR	I ² PAK	1.49 g	50	Tube

4 Revision history

Table 9. Document revision history

Date	Revision	Changes
25-Mar-2009	1	First issue

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